

DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled **PIEZOELECTRIC COMPONENT AND METHOD OF MANUFACTURING SAME** the specification of which is attached hereto unless the following box is checked:

☐ was filed on _____ as United States Application Number or PCT International Application Number _____ and was amended on _____ (if applicable).

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56.

I hereby claim foreign priority benefits under 35 U.S.C. § 119(a)-(d) or § 365(b) of any foreign application(s) for patent or inventor's certificate, or § 365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed.

Prior Foreign Application(s)		Priority Date	Priority Claimed	
10-297684	JAPAN	October 20, 1998	Yes	No
(Number)	(Country) (PCT)	(Day/Month/Year Filed)	<input checked="" type="checkbox"/>	<input type="checkbox"/>
11-195237	JAPAN	July 9, 1999	Yes	No
(Number)	(Country) (PCT)	(Day/Month/Year Filed)	<input checked="" type="checkbox"/>	<input type="checkbox"/>

I hereby claim the benefit under 35 U.S.C. § 119(e) of any United States provisional application(s) listed below.

_____	_____
(Application Number)	(Filing Date)

_____	_____
(Application Number)	(Filing Date)

I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s), or § 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application.

_____	_____	_____
(Application Number)	(Filing Date)	(Status – patented, pending, abandoned)

(Application Number)

(Filing Date)

(Status – patented, pending, abandoned)

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

Patent and Trademark Office connected therewith:

Joseph R. Keating	Reg. No. 37,368	David Abel	Reg. No. 32,394
Vincent Belusko	Reg. No. 30,820	David L. Fehrman	Reg. No. 28,600
David Henty	Reg. No. 31,323	Stefan Kirchanski	Reg. No. 36,568
Alma Levy	Reg. No. 43,751	Stuart Merkadeau	Reg. No. 33,262
Hisako Muramatsu	Reg. No. 34,955	Martin Noonan	Reg. No. 44,264
Wayne Smith	Reg. No. 42,160	David Yang	Reg. No. 44,415

Address all correspondence to:

Joseph R. Keating, Esq.
Intellectual Property Group
Graham & James LLP
801 South Figueroa, 14th Flr.
Los Angeles, CA 90017-5554
(213) 624-2500

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of first inventor (given name, family name) Koji MORITA

Inventor's signature Koji Morita Date September 27, 1999

Residence Omihachiman-shi, Shiga-Ken, Japan Citizenship Japan

Post Office Address c/o Murata Manufacturing Co., Ltd., 26-10, Tenjin 2-chome, Nagaokakyo-shi, Kyoto-fu Japan

Full name of second inventor (given name, family name) Masanobu SUGIMORI

Inventor's signature Masanobu Sugimori Date September 28, 1999

Residence Nei-gun, Toyama-ken, Japan Citizenship Japan

Post Office Address c/o Murata Manufacturing Co., Ltd., 26-10, Tenjin 2-chome, Nagaokakyo-shi, Kyoto-fu Japan

Full name of third inventor (given name, family name) Muneyuki DAIDAI

Inventor's signature Muneyuki Daidai Date September 28, 1999

Residence Toyama-shi, Toyama-ken, Japan Citizenship Japan

Post Office Address c/o Murata Manufacturing Co., Ltd., 26-10, Tenjin 2-chome, Nagaokakyo-shi, Kyoto-fu Japan